SQ4410EY

www.vishay.com

Vishay Siliconix

Automotive N-Channel 30 V (D-S) 175 °C MOSFET



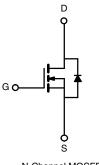
PRODUCT SUMMARY				
V _{DS} (V)	30			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.012			
$R_{DS(on)}$ (Ω) at V_{GS} = 4.5 V	0.020			
I _D (A)	15			
Configuration	Single			

FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



COMPLIANT HALOGEN



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	SQ4410EY (for detailed order number please see <u>www.vishay.com/doc?79771</u>)			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	30	V	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current	T _C = 25 °C	1	15		
	T _C = 125 °C	I _D	9		
Continuous source current (diode conduction)		۱ _S	4.5	А	
Pulsed drain current ^a		I _{DM}	60		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	38		
Single pulse avalanche energy		E _{AS}	72	mJ	
Maximum power dissipation ^a	T _C = 25 °C	- P _D	5	W	
	T _C = 125 °C		1.6	vv	
Operating junction and storage temperature rat	nge	T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^b	R _{thJA}	90	°C/W	
Junction-to-foot (drain)		R _{thJF}	30		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. When mounted on 1" square PCB (FR4 material)

1

SQ4410EY



Vishay Siliconix

SPECIFICATIONS (T _C = 25 °C PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0, I _D = 250 μA		30	-	-	v
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	1.5	2.0	2.5	v
Gate-source leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 30 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 175 °C	-	-	150	
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	20	-	-	Α
		$V_{GS} = 10 V$	I _D = 10 A	-	0.009	0.012	
Ducin actures on state registeries a	Б	$V_{GS} = 10 V$	I _D = 6 A, T _J = 125 °C	-	-	0.018	Ω
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A, T _J = 175 °C	-	-	0.021	
		$V_{GS} = 4.5 V$	I _D = 5 A	-	0.015	0.020	
Forward transconductance b	g fs	V _{DS}	= 15 V, I _D = 10 A	-	34	-	S
Dynamic ^b		<u>.</u>					
Input capacitance	C _{iss}		_S = 0 V V _{DS} = 25 V, f = 1 MHz	-	1906	2385	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	460	575	
Reverse transfer capacitance	C _{rss}			-	183	230	
Total gate charge ^c	Qg			-	35	53	
Gate-source charge ^c	Q _{gs}	$V_{GS} = 10 V$	$V_{DS} = 15 \text{ V}, I_D = 10 \text{ A}$	-	4.9	-	nC
Gate-drain charge ^c	Q _{gd}			-	5.4	-	
Gate resistance	R _g	f = 1 MHz		0.5	-	2	Ω
Turn-on delay time ^c	t _{d(on)}		V _{DD} = 15 V, R _I = 1.5 Ω		11	17	
Rise time ^c	t _r	V _{DD} =			7	11	ns
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ Ω		-	29	44	
Fall time ^c	t _f			-	8	12	1
Source-Drain Diode Ratings and Chai	acteristics ^b						
Pulsed current ^a	I _{SM}	1		-	-	60	Α
Forward voltage	V _{SD}	IF :	-	0.72	1.2	V	

Notes

c. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

d. Guaranteed by design, not subject to production testing

e. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



- 55 °C

5

Г_С

4

 $T_C = -55 \ ^\circ C$

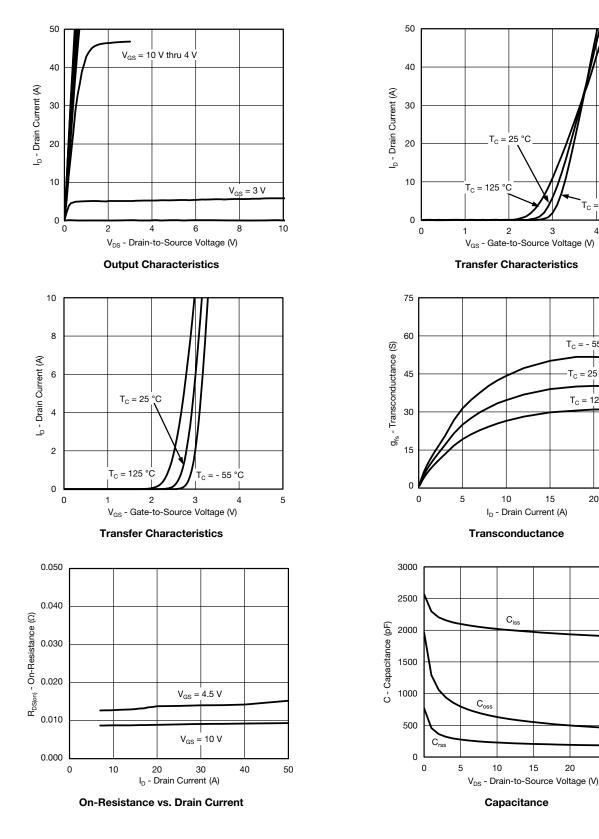
T_C = 25 °C

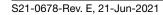
T_C = 125 °C

20

25

TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)





3

Document Number: 65674

25

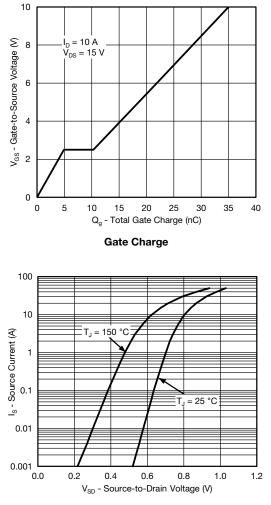
30

20

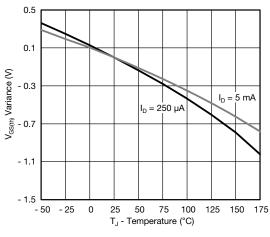
For technical questions, contact: automostechsupport@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



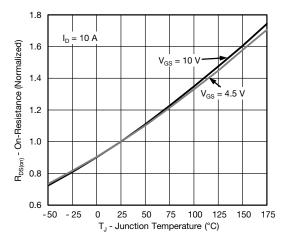
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



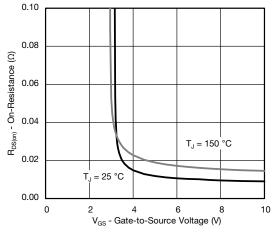
Source Drain Diode Forward Voltage



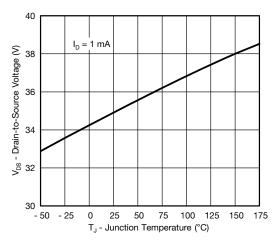
Threshold Voltage



On-Resistance vs. Junction Temperature







Drain Source Breakdown vs. Junction Temperature

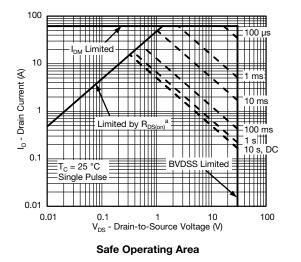
S21-0678-Rev. E, 21-Jun-2021

4 tiona contrati automostachourse Document Number: 65674

For technical questions, contact: <u>automostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)

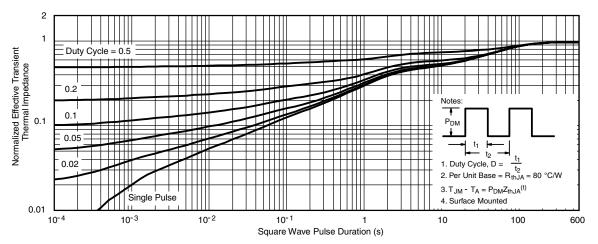


Note

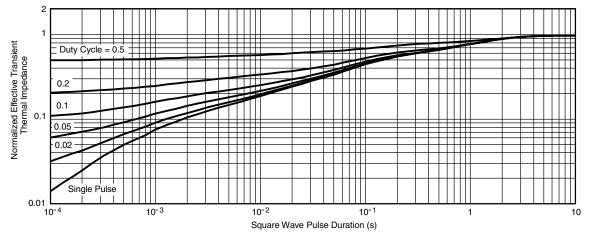
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65674.

S21-0678-Rev. E, 21-Jun-2021	6	Document Number: 65674		
	For technical questions, contact: automostechsupport@vishay.com	<u>n</u>		
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT				
ARE SUBJE	ECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishav.com</u>	<u>n/doc?91000</u>		



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIMETERS		INC	CHES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.